

PATENT ASSIGNMENT COVER SHEET

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 Stylesheet Version v1.2

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| SUBMISSION TYPE: | NEW ASSIGNMENT | |
| NATURE OF CONVEYANCE: | ASSIGNMENT | |
| SEQUENCE: | 2 | |
| CONVEYING PARTY DATA | | |
| | Name | Execution Date |
| | DKCOS | 03/03/2021 |
| RECEIVING PARTY DATA | | |
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| State/Country: | NEW YORK | |
| Postal Code: | 10001 | |
| PROPERTY NUMBERS Total: 1 | | |
| | Property Type | Number |
| | Application Number: | 29772791 |
| CORRESPONDENCE DATA | | |
| Fax Number: | | |
| <i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i> | | |
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| NAME OF SUBMITTER: | JOHN H. CHOI | |
| SIGNATURE: | /John H. Choi/ | |
| DATE SIGNED: | 03/04/2021 | |
| Total Attachments: 1 | | |
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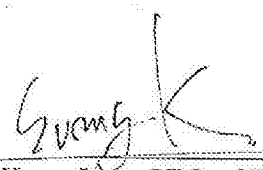
ASSIGNMENT

WHEREAS, DKCOS (hereinafter "Assignor"), a company organized under the laws of the Republic of Korea, having an address at 8F, Gwanghui building, 307 Toegye-ro, Jung-gu, Seoul, Republic of Korea, is the owner of the invention disclosed and claimed in U.S. Design Patent Application No. 29/772,791, filed on March 4, 2021.¹

WHEREAS, John JK Lee (hereinafter "Assignee"), having an address at 20 W. 33rd St., 10Fl., New York, NY 10001, is desirous of acquiring Assignor's right, title and interest in and to said invention, and any applications for patents and patents that may be granted thereon or therefrom.

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt of which is hereby acknowledged, Assignor hereby sells, assigns and sets over to said Assignee the entire right, title and interest in and for the U.S. and all other countries in and to said inventions and the aforesaid applications, all original, divisional, continuation, continuation-in-part, substitute or reissue applications and patents (or equivalents thereof) applied for or granted therefor or therefrom in the U.S. and all other countries, together with all priority rights and rights to any damages for past, present and future infringement relating to any of the aforesaid applications, and the Commissioner of Patents and Trademarks is hereby authorized and requested to issue all patents on said applications resulting therefrom to said Assignee herein as assignee of the Assignor's entire interest therein; and the undersigned and its assigns does hereby agree and covenant, without further remuneration, to execute and deliver all divisional, continuation, continuation-in-part, reissue, reexamination and other applications for patents on said inventions and all assignments thereof to said Assignee or its assigns, to communicate to said Assignee or its legal representatives all facts known to undersigned respecting said invention, to testify in any interferences or other legal proceedings in which any of said applications or patents may become involved, to sign all lawful papers, make all rightful oaths and to do generally everything necessary to aid said Assignee, its successors, assigns and nominees in obtaining patent protection on said inventions in all countries, the expenses incident to said applications to be borne and paid by said Assignee.

Date: March 3, 2021

By: 
Sung Kyun Lee, CEO of DKCOS

¹ I hereby authorize and request John H. Choi, Esq. of John H. Choi & Associates LLC to insert the application number and filing date of said application when known.